

SN54AS286, SN74AS286 9-BIT PARITY GENERATORS/CHECKERS WITH BUS-DRIVER PARITY I/O PORT

SDAS050B – DECEMBER 1983 – REVISED DECEMBER 1994

- Generate Either Odd or Even Parity for Nine Data Lines
- Cascadable for n-Bit Parity
- Direct Bus Connection for Parity Generation or Checking by Using the Parity I/O Port
- Glitch-Free Bus During Power Up/Down
- Package Options Include Plastic Small-Outline (D) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs

description

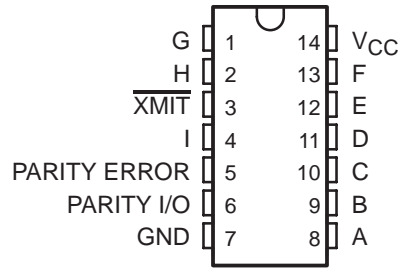
The SN54AS286 and SN74AS286 universal 9-bit parity generators/checkers feature a local output for parity checking and a 48-mA bus-driving parity input/output (I/O) port for parity generation/checking. The word-length capability is easily expanded by cascading.

The transmit ($\overline{\text{XMIT}}$) control input is implemented specifically to accommodate cascading. When $\overline{\text{XMIT}}$ is low, the parity tree is disabled and PARITY ERROR remains at a high logic level regardless of the input levels. When $\overline{\text{XMIT}}$ is high, the parity tree is enabled. PARITY ERROR indicates a parity error when either an even number of inputs (A–I) are high and PARITY I/O is forced to a low logic level, or when an odd number of inputs are high and PARITY I/O is forced to a high logic level.

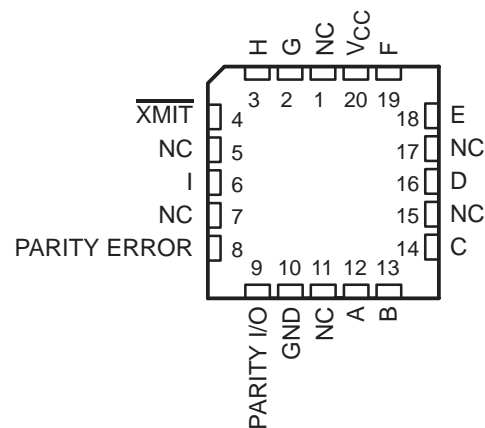
The I/O control circuitry was designed so that the I/O port remains in the high-impedance state during power up or power down to prevent bus glitches.

The SN54AS286 is characterized for operation over the full military temperature range of -55°C to 125°C . The SN74AS286 is characterized for operation from 0°C to 70°C .

SN54AS286 . . . J PACKAGE
SN74AS286 . . . D OR N PACKAGE
(TOP VIEW)



SN54AS286 . . . FK PACKAGE
(TOP VIEW)



NC – No internal connection

FUNCTION TABLE

NUMBER OF INPUTS (A–I) THAT ARE HIGH	$\overline{\text{XMIT}}$	PARITY I/O	PARITY ERROR
0, 2, 4, 6, 8	l	H	H
1, 3, 5, 7, 9	l	L	H
0, 2, 4, 6, 8	h	h	H
	h	l	L
1, 3, 5, 7, 9	h	h	L
	h	l	H

h = high input level
H = high output level

l = low input level
L = low output level

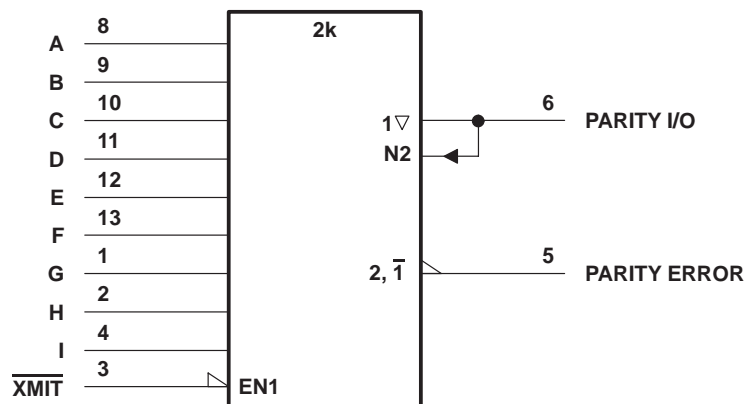
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9-BIT PARITY GENERATORS/CHECKERS

WITH BUS-DRIVER PARITY I/O PORT

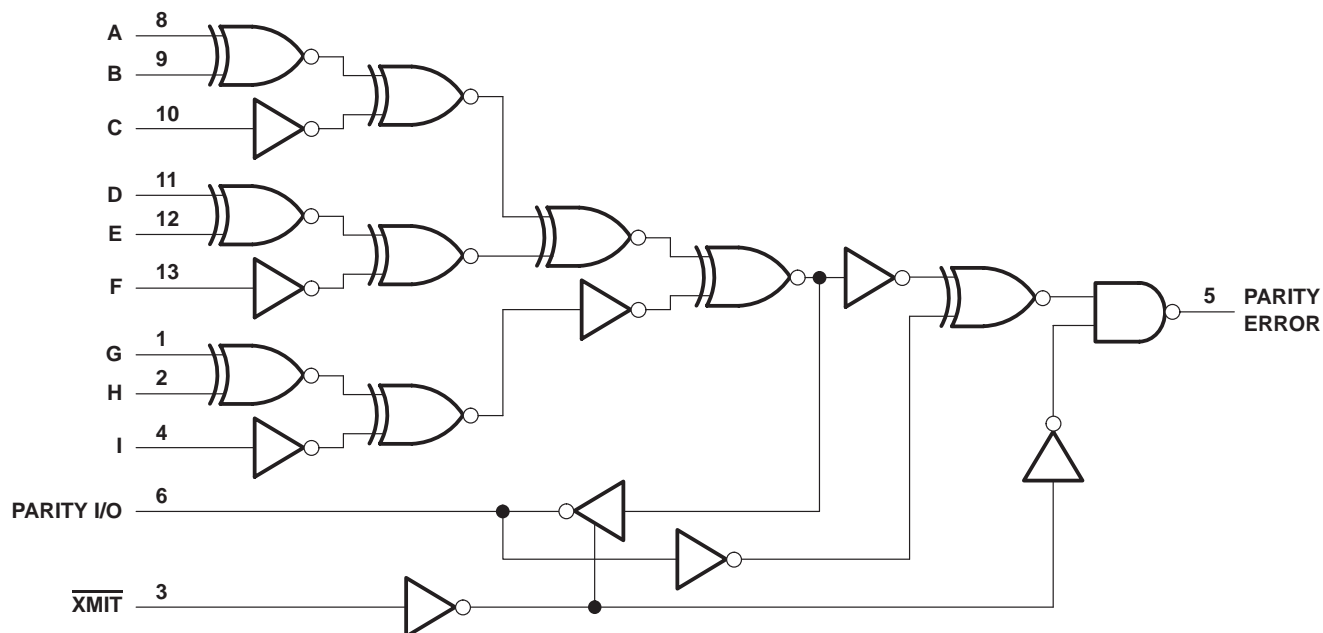
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logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.
Pin numbers shown are for the D, J, and N packages.

logic diagram (positive logic)



Pin numbers shown are for the D, J, and N packages.

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V_{CC}	7 V
Input voltage, V_I	7 V
Voltage applied to a disabled 3-state output	5.5 V
Operating free-air temperature range, T_A : SN54AS286	–55°C to 125°C
SN74AS286	0°C to 70°C
Storage temperature range	–65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

			SN54AS286			SN74AS286			UNIT
			MIN	NOM	MAX	MIN	NOM	MAX	
V _{CC}	Supply voltage		4.5	5	5.5	4.5	5	5.5	V
V _{IH}	High-level input voltage		2			2			V
V _{IL}	Low-level input voltage		0.8			0.8			V
I _{OH}	High-level output current	PARITY ERROR	−2			−2			mA
		PARITY I/O	−12			−15			
I _{OL}	Low-level output current	PARITY ERROR	20			20			mA
		PARITY I/O	32			48			
T _A	Operating free-air temperature		−55	125		0	70		°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		SN54AS286			SN74AS286			UNIT
				MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V _{IK}		V _{CC} = 4.5 V,	I _I = –18 mA	–1.2			–1.2			V
V _{OH}	All outputs	V _{CC} = 4.5 V to 5.5 V,	I _{OH} = –2 mA	V _{CC} – 2			V _{CC} – 2			V
	PARITY I/O	V _{CC} = 4.5 V	I _{OH} = –3 mA	2.4	2.9		2.4	3		
			I _{OH} = –12 mA	2.4						
			I _{OH} = –15 mA				2.4			
V _{OL}	PARITY ERROR	V _{CC} = 4.5 V	I _{OL} = 20 mA	0.35	0.5		0.35	0.5	V	
	PARITY I/O		I _{OL} = 32 mA		0.5					
			I _{OL} = 48 mA				0.5			
I _I	PARITY I/O	V _{CC} = 5.5 V	V _I = 5.5 V		0.1			0.1	mA	
	All other inputs		V _I = 7 V		0.1		0.1			
I _{IH}	PARITY I/O§	V _{CC} = 5.5 V,	V _I = 2.7 V		50		50	µA		
	All other inputs				20		20			
I _{IL}	PARITY I/O§	V _{CC} = 5.5 V,	V _I = 0.4 V		–0.5		–0.5	mA		
	All other inputs				–0.5		–0.5			
I _O ¶		V _{CC} = 5.5 V,	V _O = 2.25 V	–30	–112		–30	–112	mA	
I _{CC}	Transmit	V _{CC} = 5.5 V		30	43		30	43	mA	
	Receive			35	50		35	50		

‡ All typical values are at $V_{CC} = 5$ V, $T_A = 25^\circ\text{C}$.

§ For I/O ports, the parameters I_{IH} and I_{IL} include the off-state output current.

¶ The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, I_{OS} .



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switching characteristics (see Figure 3)

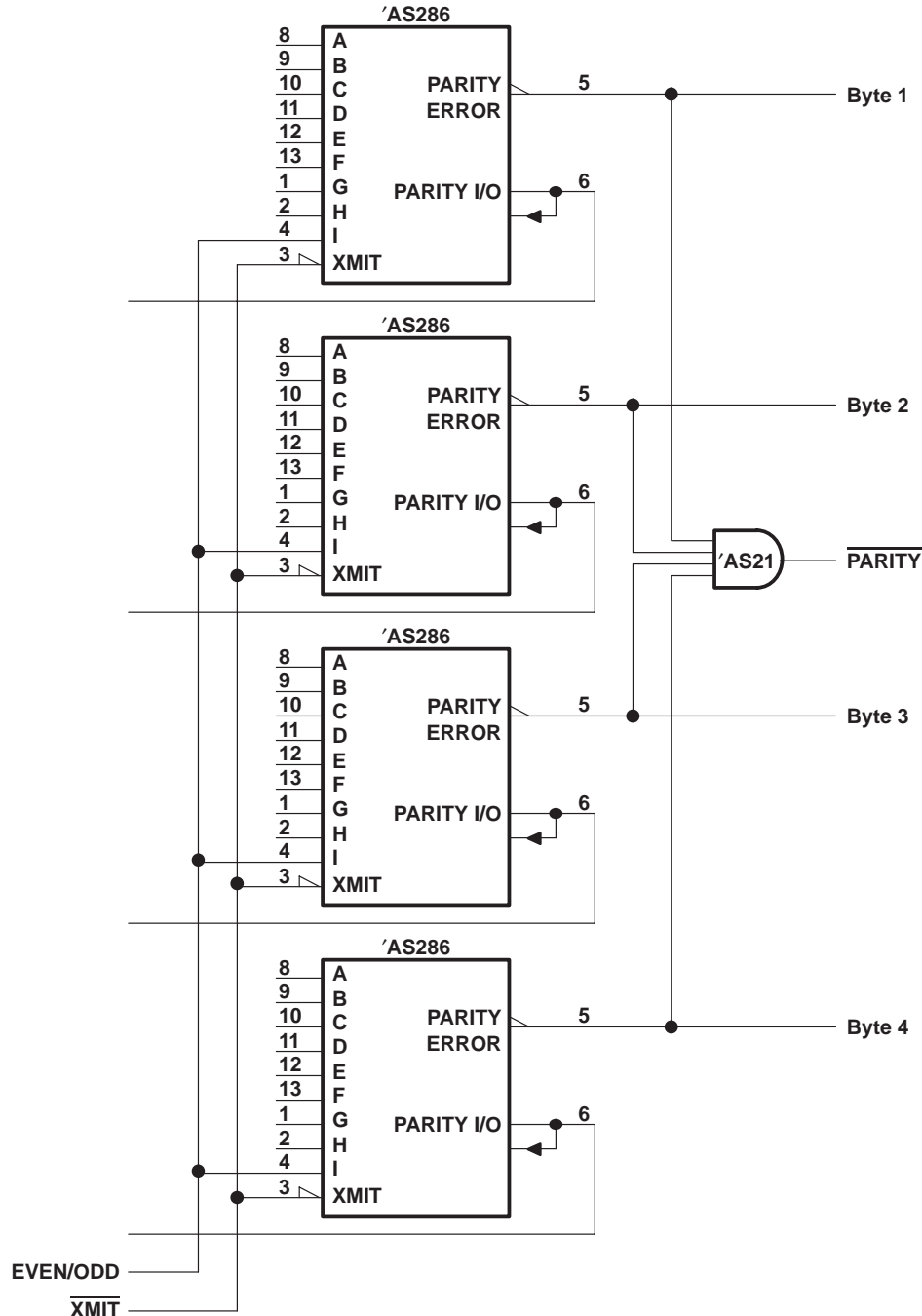
PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} = 4.5 V to 5.5 V, C _L = 50 pF, R ₁ = 500 Ω, R ₂ = 500 Ω, T _A = MIN to MAX†				UNIT
			SN54AS286		SN74AS286		
			MIN	MAX	MIN	MAX	
t _{PLH}	Any A – I	PARITY I/O	3	17	3	15	ns
t _{PHL}			3	15	3	14	
t _{PLH}	Any A – I	PARITY ERROR	3	20	3	16.5	ns
t _{PHL}			3	18	3	16.5	
t _{PLH}	PARITY I/O	PARITY ERROR	3	10	3	9	ns
t _{PHL}			3	10	3	9	
t _{PZH}	$\overline{\text{XMIT}}$	PARITY I/O	3	14	3	13	ns
t _{PZL}			3	17	3	16	
t _{PHZ}	$\overline{\text{XMIT}}$	PARITY I/O	3	13	3	11.5	ns
t _{PLZ}			3	11	3	10	

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.



APPLICATION INFORMATION

Figure 1 shows a 32-bit parity generator/checker with output polarity switching, parity-error detection, and parity on every byte.



Pin numbers shown are for the D, J, and N packages.

Figure 1. 32-Bit Parity Generator/Checker

SN54AS286, SN74AS286

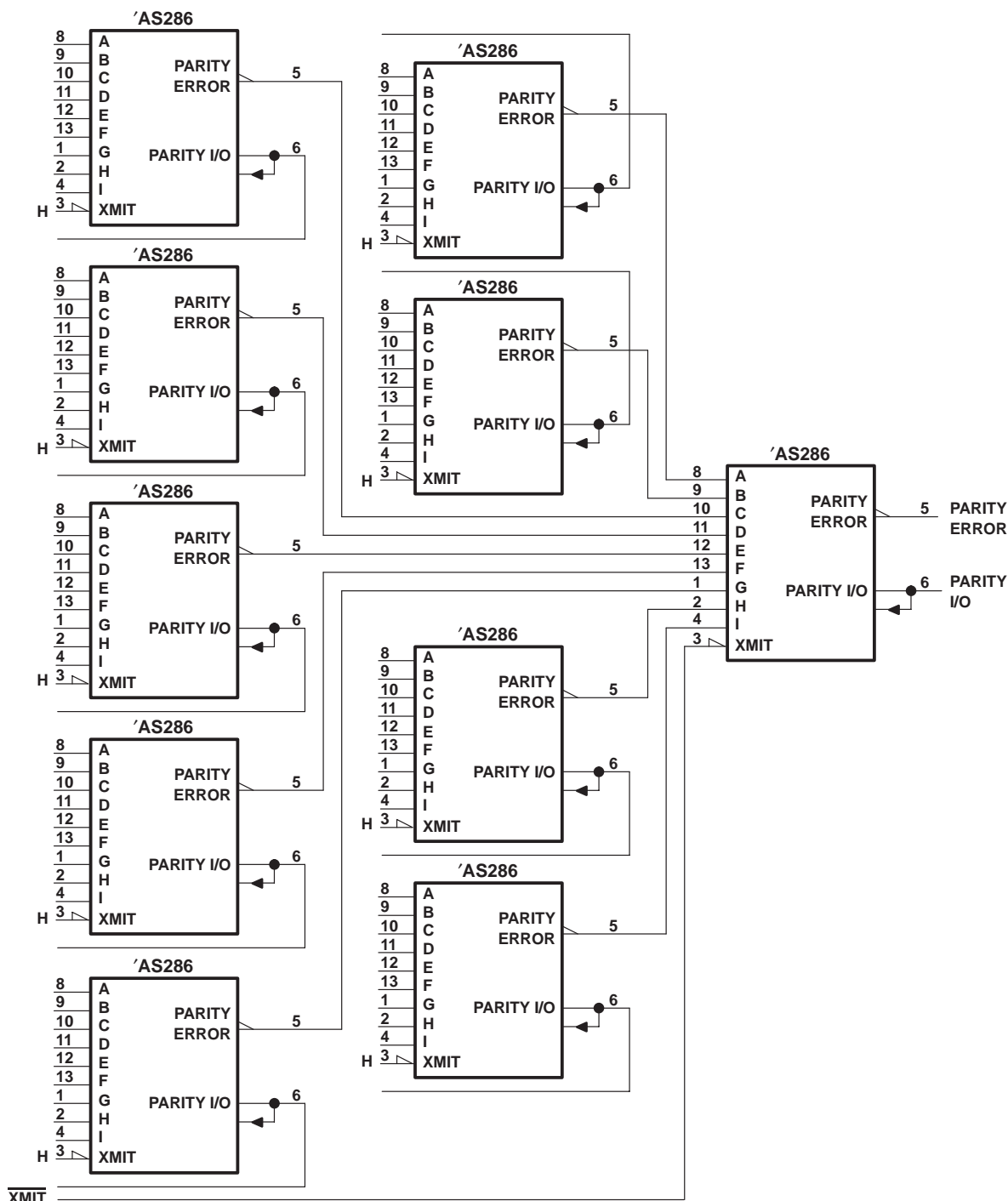
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APPLICATION INFORMATION

Figure 2 shows a 90-bit parity generator/checker with $\overline{\text{XMIT}}$ on the last stage available for use with parity detection.



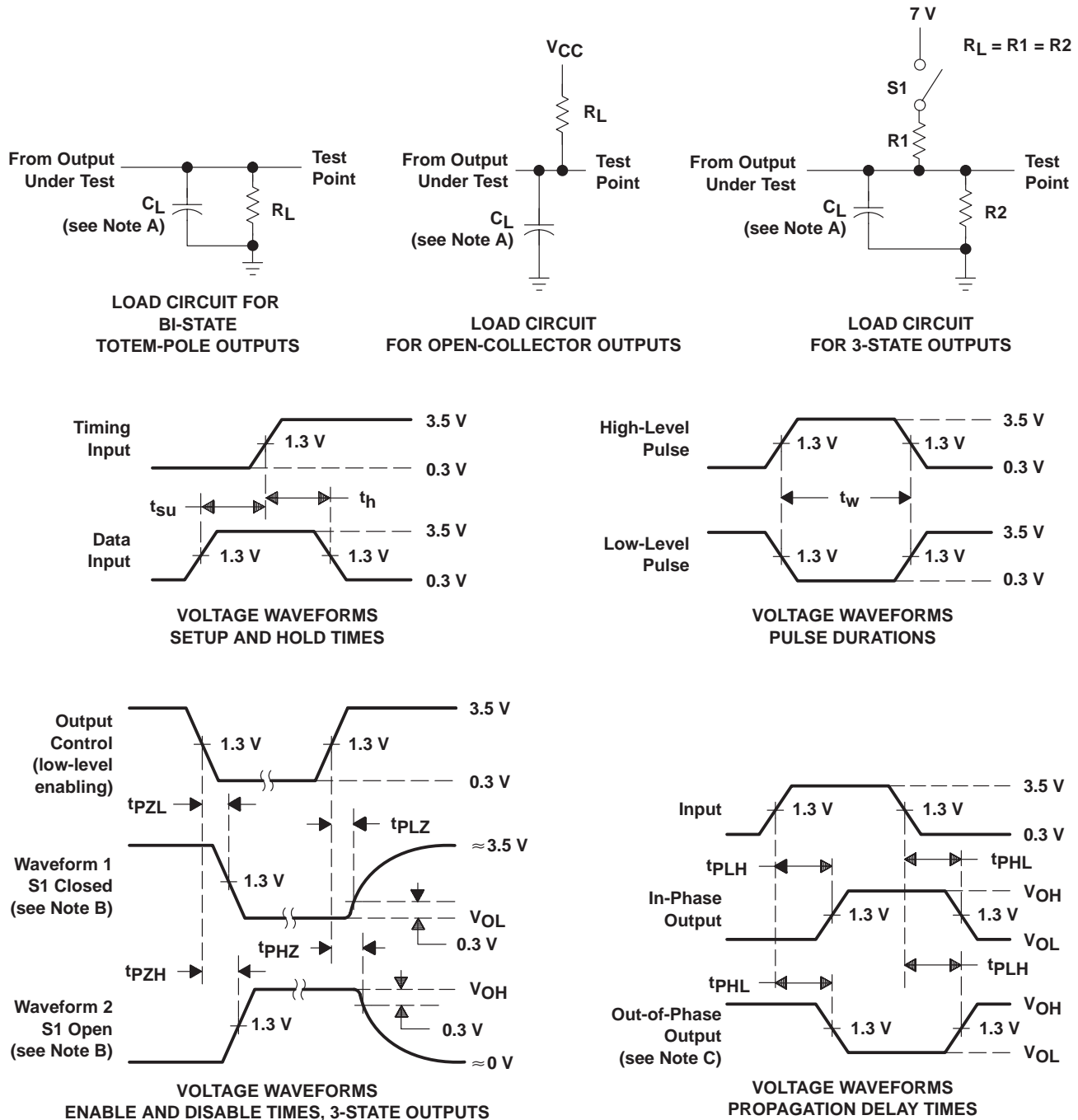
Pin numbers shown are for the D, J, and N packages.

Figure 2. 90-Bit Parity Generator/Checker With Parity-Error Detection



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PARAMETER MEASUREMENT INFORMATION SERIES 54ALS/74ALS AND 54AS/74AS DEVICES



- NOTES: A. C_L includes probe and jig capacitance.
B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
D. All input pulses have the following characteristics: $PRR \leq 1$ MHz, $t_r = t_f = 2$ ns, duty cycle = 50%.
E. The outputs are measured one at a time with one transition per measurement.

Figure 3. Load Circuits and Voltage Waveforms

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
SN74AS286D	Active	Production	SOIC (D) 14	50 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	AS286
SN74AS286D.A	Active	Production	SOIC (D) 14	50 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	AS286

- (1) **Status:** For more details on status, see our [product life cycle](#).
- (2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.
- (3) **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.
- (4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.
- (5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.
- (6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
SN74AS286D	D	SOIC	14	50	506.6	8	3940	4.32
SN74AS286D.A	D	SOIC	14	50	506.6	8	3940	4.32

D0014A**PACKAGE OUTLINE****SOIC - 1.75 mm max height**

SMALL OUTLINE INTEGRATED CIRCUIT



4220718/A 09/2016

NOTES:

1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm, per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm, per side.
5. Reference JEDEC registration MS-012, variation AB.

EXAMPLE BOARD LAYOUT

D0014A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



LAND PATTERN EXAMPLE
SCALE:8X



SOLDER MASK DETAILS

4220718/A 09/2016

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

D0014A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:8X

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NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

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